

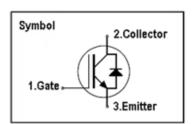
IGBT

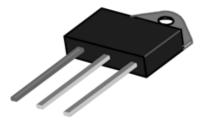
Features

- 650V,40A
- $V_{CE(sat)(typ.)}$ =2.0V@ V_{GE} =15V, I_{C} =40A
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA



JIAEN Trench IGBTs offer lower losses and higher energy efficiency for application such as Motor control, general inverter and other soft switching applications.





Absolute Maximum Ratings

Symbol	Parameter	Value	Units
Vces	Collector-Emitter Voltage	650	V
V _{GES}	Gate-Emitter Voltage	<u>+</u> 30	V
I.	Continuous Collector Current (Tc=25 °C)	80	А
lc lc	Continuous Collector Current (Tc=100°C)	40	А
Ісм	Pulsed Collector Current (Note 1)	120	А
l _F	Diode Continuous Forward Current (T _C =100 °C)	40	A
I _{FM}	Diode Maximum Forward Current (Note 1)	120	А
t _{sc}	Short Circuit Withstand Time	10	us
D-	Maximum Power Dissipation (T _C =25 °C)	278	W
P _D	Maximum Power Dissipation (Tc=100°C)	111	W
TJ	Operating Junction Temperature Range	-55 to +150	°C
T _{STG}	Storage Temperature Range	-55 to +150	°C

Thermal Characteristics

Symbol	Parameter	Max.	Units
R _{th j-c}	Thermal Resistance, Junction to case for IGBT	0.45	°C/ W
R _{th j-c}	Thermal Resistance, Junction to case for Diode	1.5	°C/ W
R _{th j-a}	Thermal Resistance, Junction to Ambient	40	°C/ W



Electrical Characteristics (Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
BV _{CES}	Collector-Emitter Breakdown Voltage	V_{GE} = 0V, I_{C} = 250uA	650	-	-	V
I _{CES}	Collector-Emitter Leakage Current	V _{CE} = 650V, V _{GE} = 0V	-	-	100	uA
I _{GES}	Gate Leakage Current, Forward	V_{GE} = ±20 V, V_{CE} = 0 V	-	-	±100	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$, $I_{C} = 250uA$	5.1	-	6.9	V
V _{CE(sat)}	Collector-Emitter Saturation Voltage	V _{GE} =15V, I _C = 40A	-	2.0	2.5	V
Qg	Total Gate Charge	Vcc=480V	-	594		nC
Qge	Gate-Emitter Charge	V _{GE} =15V	-	119		nC
Qgc	Gate-Collector Charge	Ic=40A	-	374		nC
t d(on)	Turn-on Delay Time		-	19	-	ns
t r	Turn-on Rise Time	Vcc=400V	-	65	-	ns
t d(off)	Turn-off Delay Time	V _{GE} =15V	-	86	-	ns
t f	Turn-off Fall Time	I _C =40A R _G =15Ω	-	98	-	ns
Eon	Turn-on Switching Loss	Inductive Load	-	1.3	-	mJ
Eoff	Turn-off Switching Loss	T _C =25 ℃	-	0.5	-	mJ
Ets	Total Switching Loss		-	1.8	-	mJ
C _{ies}	Input Capacitance	Vce=25V	-	1340	-	pF
Coes	Output Capacitance	V _{GE} =0V	-	98	-	pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz	-	11.8	-	pF

Electrical Characteristics of Diode (Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _F	Diode Forward Voltage	I _F =40A	-	1.5	3.0	V
trr	Diode Reverse Recovery Time	V _{CE} = 400V	-	148		ns
Irr	Diode peak Reverse Recovery Current	I _F = 40A	-	13.8		Α
Qrr	Diode Reverse Recovery Charge	Rg=15 Ω	-	1055		nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature



Typical Performance Characteristics

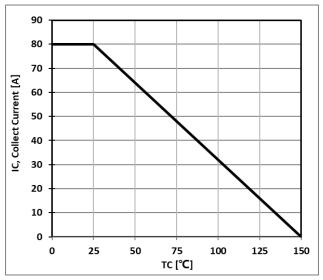


Figure 1: Maximum DC Collector Current VS. case temprature

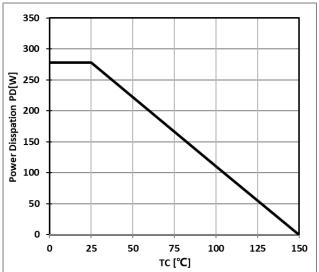


Figure 2: Power Dissipation VS. Case Temperature

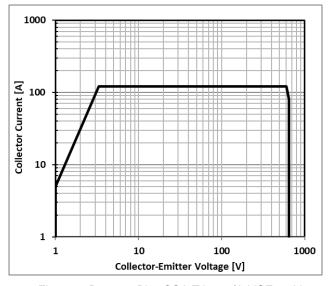


Figure 3: Reverse Bias SOA,TJ=125℃,VGE=15V

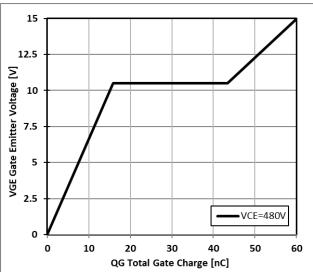


Figure 4: Typical Gate charge VS. VGE,IC=40A



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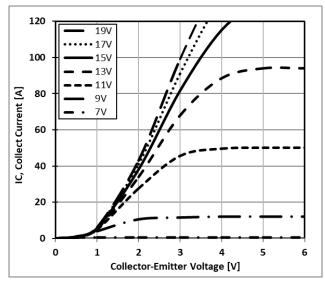


Figure 5: Typical IGBT Output characteristics, $TC=25^{\circ}C$;tp=300us

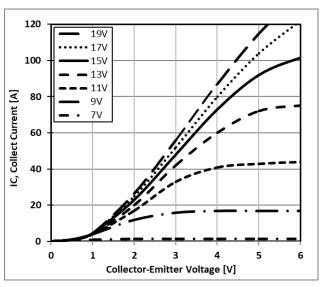


Figure 6: Typical IGBT Output characteristics, TC=150°C;tp=300us

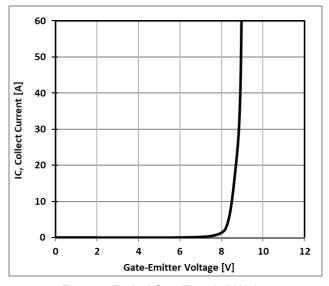


Figure 7: Typical Gate Threshold Voltage

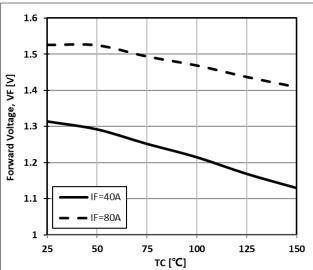


Figure 8: Typical Forward Voltage vs IF





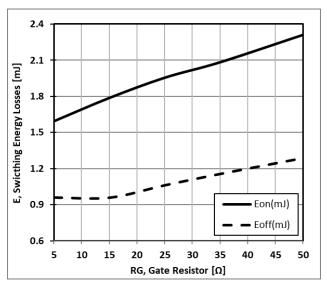


Figure 9: Typical Energy Loss VS. RG, TC=25 °C, L=200uH,VCE=400V,VGE=15V,IC=40A

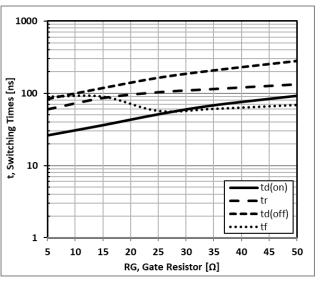


Figure 10: Typical Switching Time VS. RG, TC=25°C, L=200uH,VCE=400V,VGE=15V,IC=40A

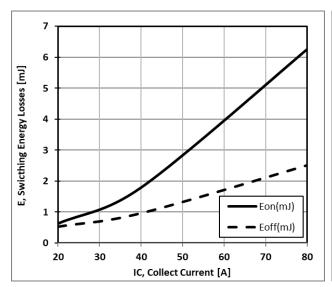


Figure 11: Typical Energy Loss VS. IC,TC=25 $^{\circ}$ C, L=200uH, VCE=400V, VGE=15V,RG=15 $^{\Omega}$

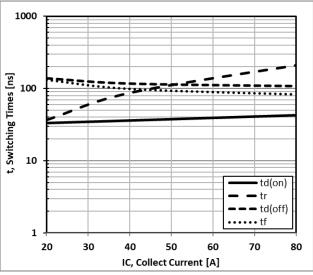


Figure 12: Typical Switching Time VS. IC,TC=25 $^{\circ}$ C, L=200uH,VCE=400V,VGE=15V,RG=15 $^{\circ}$



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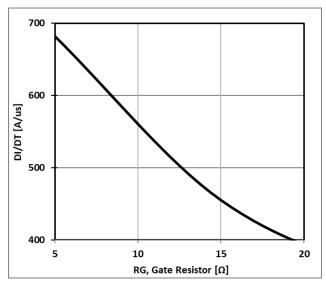


Figure 13: Typical Diode DI/DT VS. RG,TC=25°C VCC=400V, VGE=15V, IF=40A

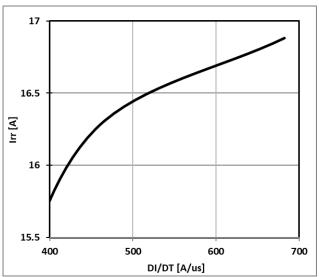


Figure 14: Typical Diode IRR VS. DI/DT,TC=25°C VCC=400V,VGE=15V, IF=40A

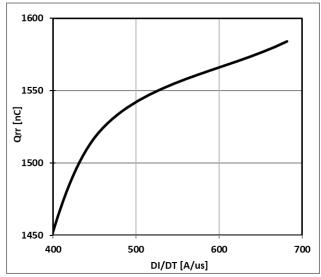


Figure 15: Typical Diode Qrr VS. DI/DT,TC=25℃ VCC=400V, VGE=15V, IF=40A

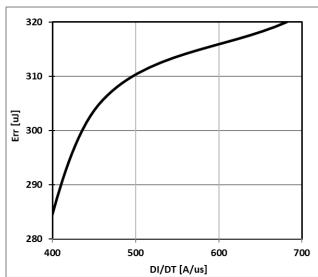
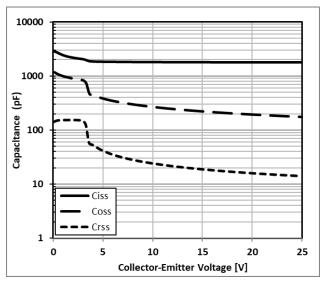
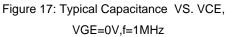


Figure 16: Typical Diode Err VS. DI/DT,TC=25 $^{\circ}$ C VCC=400V, VGE=15V, IF=40A



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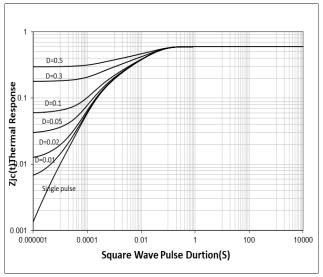
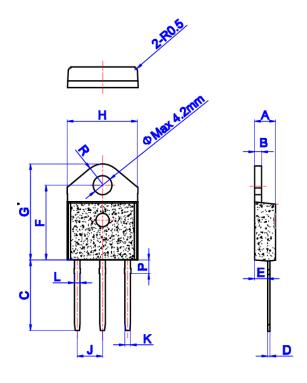


Figure 18: Normalized transient thermal impedance junction-to-case



TO-3P-II PACKAGE OUTLINE



	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
A	4.40		4.60	0.173		0.181	
В	1.45		1.55	0.057		0.061	
С	14.35		15.60	0.565		0.614	
D	0.50		0.70	0.020		0.028	
E	2.70		2.90	0.106		0.114	
F	15.80		16.50	0.622		0.650	
G	20.40		21.10	0.803		0.831	
Н	15.10		15.50	0.594		0.610	
J	5.40		5.65	0.213		0.222	
К	1.10		1.40	0.043		0.055	
L	1.35		1.50	0.053		0.059	
Р	2.80		3.00	0.110		0.118	
R		4.35			0.171		





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